

LTspice Model Forward/Reverse H-bridge Driver ON Semiconductor LV8760T-TLM-E

Model Information

Model A macro model

Call Name MDC_LV8760T-TLM-E_LT

Pin Assign 1:PGND 2,3:OUTB 4,5:RNF 6,7:VM 8,9:OUTA 10:PS 11:GND 12:VG 13:CP2 14:CP1

15:REG5 16:IN1 17:IN2 18:VREF 19:SCP VCC

File List Model Library MDC_LV8760T-TLM-E_LT02.lib

Model Report MDC_LV8760T-TLM-E_LT.pdf(this file)

Model Report MDO_EVOTOOT TEM E_ET:pai(tillo liic

Verified Simulator Version

LTspice XVII

Note

References

The information which was used for modeling is as follow:

[Data Sheet]

Date/VersionProduct nameCompany nameAugust, 2013LV8760T-TLM-EON Semiconductor

[Characteristics listed]

CharacteristicsVREG, VthVCC, VthHIS

Ron1, Ron2, I0leak, tr, tf, tpLH, tpHL, VGH, tONG, Fcp, IINL, IINH, VINH, VINH,

IREF, Vthlim, TBLK, Iscp, Vthscp

Simulation Condition

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Condition			l lmi4
	Min	Тур	Max	Unit
Vm supply voltage	9		35	V
Vcc supply voltage	3		5.5	V
Temperature		25		deg C



Model Functions Table

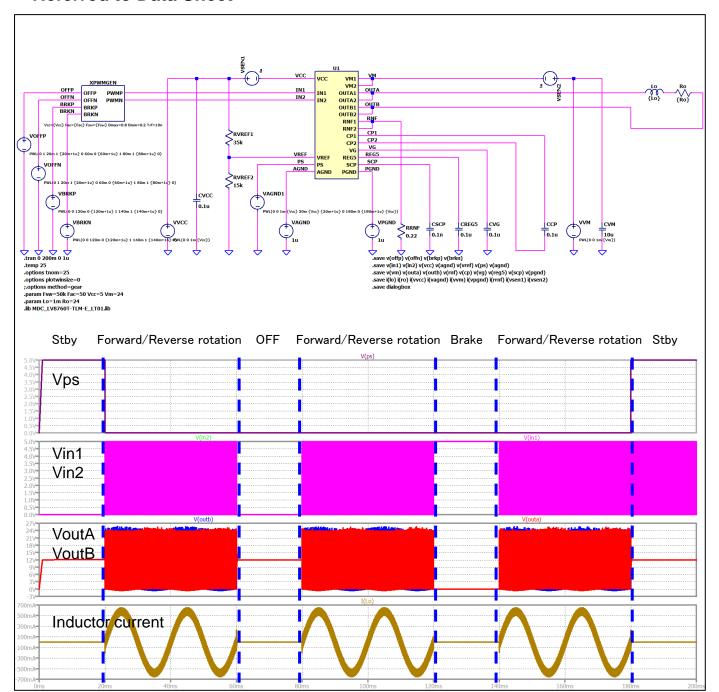
Functions	Implemented
DCM output control logic	0
Current limit control	0
Output short-circuit protection function	0
UVLO	0

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Testbench for PWM, brake, stand-by mode (PWM: Fin=50[Hz] Fc=50[kHz], Lo = 1[mH], Ro = 1[A])

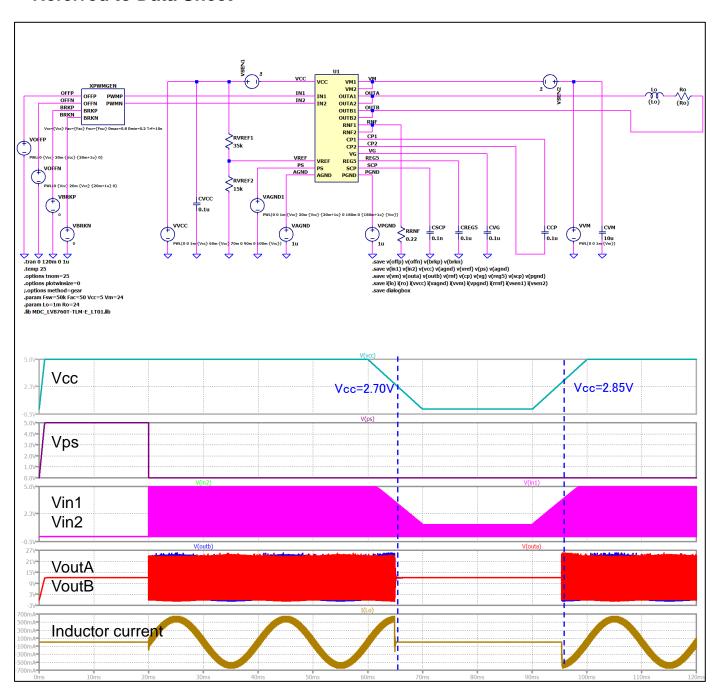
Referred to Data Sheet





Testbench for UVLO (Lout=1[nH] Rout=24[ohm])

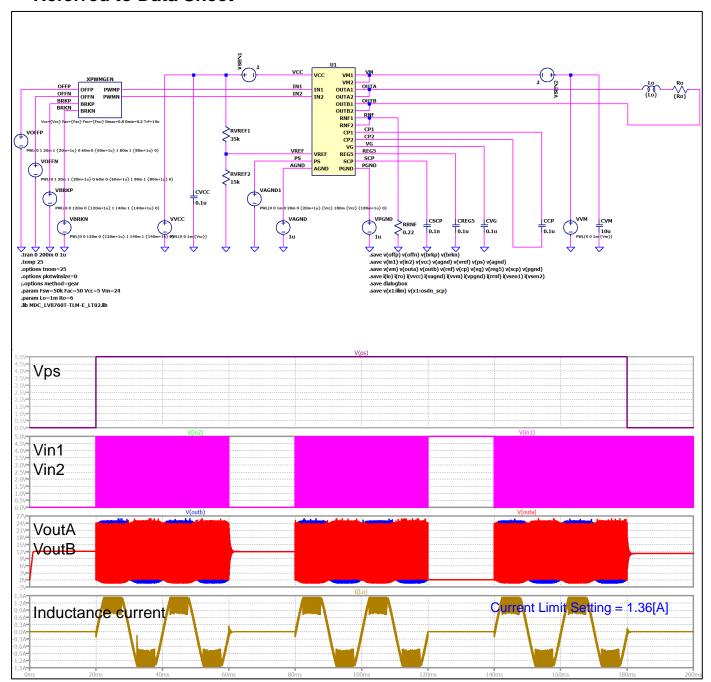
Referred to Data Sheet





Testbench for OCP (PWM : Fin = 50[Hz] Fc= 50[kHz], Lo = 1[mH], Ro = 6[ohm], Vref = 1.5[V])

Referred to Data Sheet





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